Poly-Pad® K-10

Polyester-Based, Thermally Conductive Insulation Material

Features and Benefits

- Thermal impedance: 0.60°C-in²/W (@50 psi)
- Polyester based
- For applications requiring non-silicone conformal coatings
- Designed for silicone-sensitive applications
- Excellent dielectric strength and thermal performance



Poly-Pad K-10 is a composite of film coated with a polyester resin. The material offers superior thermal performance for your most critical applications with a thermal resistance of 0.2°C-in²/W as well as excellent dielectric strength.

Polyester-based, thermally conductive insulators from Bergquist provide a complete family of materials for silicone-sensitive applications. Poly-Pads are ideally suited for applications requiring conformal coatings or applications where silicone contamination is a concern (telecomm and certain aerospace applications). Poly-Pads are constructed with ceramic-filled polyester resins coating either side of a fiberglass carrier or a film carrier. The Poly-Pad family offers a complete range of performance characteristics to match individual applications.

TYPICAL PROPERTIES OF POLY-PAD K-10					
PROPERTY	IMPERIAL VALUE	METRIC VA	LUE TEST	METHOD	
Color	Yellow	Yellow		Visual	
Reinforcement Carrier	Kapton	Kapton		_	
Thickness (inch) / (mm)	0.006	0.152	AS	ASTM D374	
Hardness (Shore A)	90	90	90 ASTM D2240		
Breaking Strength (lbs/inch) / (kN/m)	30	5	AS ⁻	ASTM D1458	
Elongation (%)	40	40	AS	ASTM D412	
Tensile Strength (psi) / (MPa)	5000	34	AS	ASTM D412	
Continuous Use Temp (°F) / (°C)	-4 to 302	-4 to 302 -20 to 150		_	
ELECTRICAL					
Dielectric Breakdown Voltage (Vac)	6000 6000		AS	ASTM D149	
Dielectric Constant (1000 Hz)	3.7	3.7	AS	ASTM D150	
Volume Resistivity (Ohm-meter)	10 ¹²	10 ¹²	AS	ASTM D257	
Flame Rating	V-O	V-O		U.L.94	
THERMAL					
Thermal Conductivity (W/m-K)	1.3	1.3	AS	TM D5470	
THERMAL PERFORMANCE vs PRESSURE					
Press	sure (psi) 10	25	50 100	200	
TO-220 Thermal Performance	e (°C/W) 3.76	3.35	2.75 2.30	2.03	
Thermal Impedance (°C-ir	1.04 n ² /W) (1)	0.80	0.43	0.30	

1) The ASTM D5470 test fixture was used. The recorded value includes interfacial thermal resistance. These values are provided for reference only. Actual application performance is directly related to the surface roughness, flatness and pressure applied.

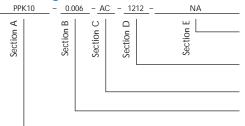
Typical Applications Include:

- · Power supplies
- Motor controls
- Power semiconductors

Configurations Available:

- · Sheet form, die-cut parts and roll form
- With or without pressure sensitive adhesive

Building a Part Number



Standard Options

← example

NA = Selected standard option. If not selecting a standard option, insert company name, drawing number, and revision level

_ _ = Standard configuration dash number, 1212 = 12" x 12" sheets, 12/250 = 12" x 250' rolls, or 00 = custom configuration

AC = Adhesive, one side 00 = No adhesive

Standard thicknesses available: 0.006"

PPK10 = Poly-Pad K-10 Material

Note: To build a part number, visit our website at www.bergquistcompany.com.

Sil-Pad*: U.S. Patents 4,574,879; 4,602,125; 4,602,678; 4,685,987; 4,842,911 and others

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